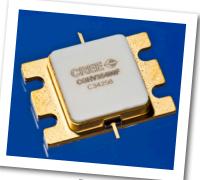


# **CGHV35400F** 400 W, 2900 - 3500 MHz, 50-Ohm Input/Output Matched, GaN HEMT for S-Band Radar Systems

Cree's CGHV35400F is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV35400F ideal for 2.9 - 3.5 GHz S-Band radar amplifier applications. The transistor is supplied in a ceramic/metal flange package, type 440210.



PN: CGHV35400F Package Type: 440215

#### Typical Performance Over 2.9-3.5 GHz ( $T_c = 85^{\circ}C$ ) of Demonstration Amplifier

Parameter	2.9 GHz	3.2 GHz	3.5 GHz	Units
Output Power	375	400	360	W
Gain	9.8	10	9.6	dB
Drain Efficiency	66	59	57	%

Note:

Measured in the CGHV35400F-AMP1 application circuit, under 500  $\mu$ s pulse width, 10% duty cycle, P<sub>IN</sub> = 46 dBm.

#### **Features**

- 2.9 3.5 GHz Operation
- 400 W Typical Output Power
- 10.5 dB Power Gain
- 60% Typical Drain Efficiency
- 50 Ohm Internally Matched
- <0.3 dB Pulsed Amplitude Droop



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#### Absolute Maximum Ratings (not simultaneous)

Parameter	Symbol	Rating	Units	Conditions
Pulse Width	PW	500	μs	
Duty Cycle	DC	10	%	
Drain-Source Voltage	V <sub>DSS</sub>	125	Volts	25°C
Gate-to-Source Voltage	V <sub>GS</sub>	-10, +2	Volts	25°C
Storage Temperature	T <sub>stg</sub>	-65, +150	°C	
Operating Junction Temperature	Tj	225	°C	
Maximum Forward Gate Current	I <sub>gmax</sub>	80	mA	25°C
Maximum Drain Current <sup>1</sup>	I <sub>DMAX</sub>	24	А	25°C
Soldering Temperature <sup>2</sup>	Τ <sub>s</sub>	245	°C	
Screw Torque	τ	40	in-oz	
Pulsed Thermal Resistance, Junction to Case	R <sub>eJC</sub>	0.22	°C/W	100 $\mu sec,$ 10%, 85°C , $P_{_{\text{DISS}}}$ = 418 W
Pulsed Thermal Resistance, Junction to Case	R <sub>eJC</sub>	0.30	°C/W	500 µsec, 10%, 85°C, P <sub>DISS</sub> = 418 W
Case Operating Temperature	Т <sub>с</sub>	-40, +85	°C	

Notes:

 $^{\scriptscriptstyle 1}$  Current limit for long term, reliable operation

<sup>2</sup> Refer to the Application Note on soldering at http://www.cree.com/rf/tools-and-support/document-library

#### **Electrical Characteristics**

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions	
DC Characteristics <sup>1</sup> (T <sub>c</sub> = 25°C)							
Gate Threshold Voltage	$V_{\rm GS(th)}$	-3.8	-3.0	-2.3	V <sub>DC</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 83.6 mA	
Gate Quiescent Voltage	V <sub>GS(Q)</sub>	-	-2.7	-	V <sub>DC</sub>	V <sub>DS</sub> = 45 V, I <sub>D</sub> = 0.5 A	
Saturated Drain Current <sup>2</sup>	I <sub>DS</sub>	62.7	75.5	-	А	$V_{_{DS}}$ = 6.0 V, $V_{_{GS}}$ = 2.0 V	
Drain-Source Breakdown Voltage	V <sub>BR</sub>	150	-	-	V <sub>DC</sub>	V <sub>GS</sub> = -8 V, I <sub>D</sub> = 83.6 mA	

Notes:

<sup>1</sup> Measured on wafer prior to packaging.

<sup>2</sup> Scaled from PCM data.

CGHV35400F Rev 2.0



#### **Electrical Characteristics Continued...**

Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions	
RF Characteristics <sup>3</sup> ( $T_c = 85^{\circ}C$ , $F_0 = 2.9 - 3.5$ GHz unless otherwise noted)							
Output Power at 2.9 GHz	P <sub>OUT1</sub>	340	375	-	W	$V_{_{DD}}$ = 45 V, $I_{_{DQ}}$ = 500 mA, $P_{_{IN}}$ = 46 dBm	
Output Power at 3.2 GHz	P <sub>OUT2</sub>	340	400	-	W	$V_{_{DD}}$ = 45 V, $I_{_{DQ}}$ = 500 mA, $P_{_{IN}}$ = 46 dBm	
Output Power at 3.5 GHz	P <sub>OUT3</sub>	300	360	-	W	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Gain at 2.9 GHz	G <sub>P1</sub>	9.3	9.8	-	dB	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Gain at 3.2 GHz	G <sub>P2</sub>	9.3	10.0	-	dB	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Gain at 3.5 GHz	G <sub>P3</sub>	8.7	9.6	-	dB	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Drain Efficiency at 2.9 GHz	D <sub>E1</sub>	58	66	-	%	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Drain Efficiency at 3.2 GHz	D <sub>E2</sub>	53	59	-	%	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Drain Efficiency at 3.5 GHz	D <sub>E3</sub>	48	57	-	%	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Small Signal Gain	S21	10.5	12	-	dB	$V_{_{\rm DD}}$ = 45 V, $I_{_{\rm DQ}}$ = 500 mA, $P_{_{\rm IN}}$ = -10 dBm	
Input Return Loss	S11	-	-8	-3.0	dB	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = -10 dBm	
Output Return Loss	S22	-	-8	-4.0	dB	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = -10 dBm	
Amplitude Droop	D	-	-0.3	-	dB	$V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, P $_{_{IN}}$ = 46 dBm	
Output Stress Match	VSWR	-	5:1	-	Ψ	No damage at all phase angles, $V_{_{DD}}$ = 45 V, I $_{_{DQ}}$ = 500 mA, $P_{_{IN}}$ = 46 dBm Pulsed	

Notes:

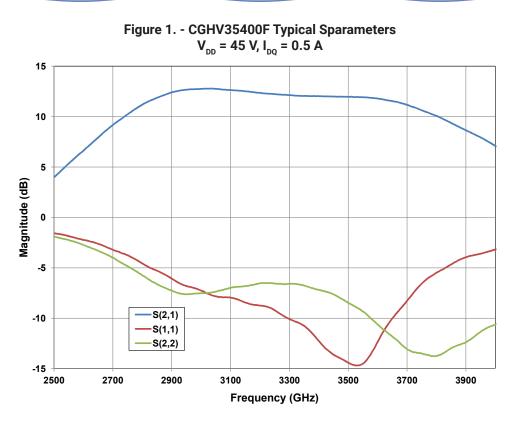
 $^3$  Measured in CGHV35400F-AMP1. Pulse Width = 500  $\mu\text{S},$  Duty Cycle = 10%.

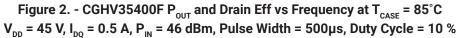
## **Electrostatic Discharge (ESD) Classifications**

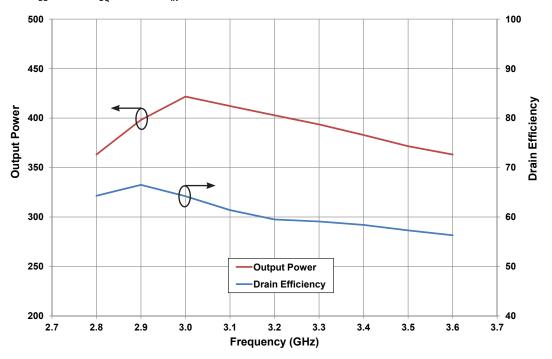
Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (200 < 500 V)	JEDEC JESD22 C101-C



# **Typical Performance**





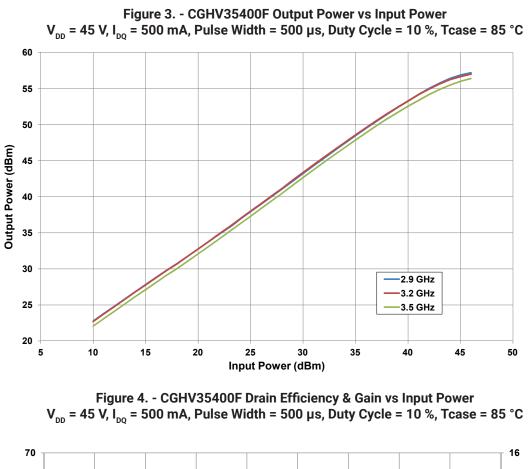


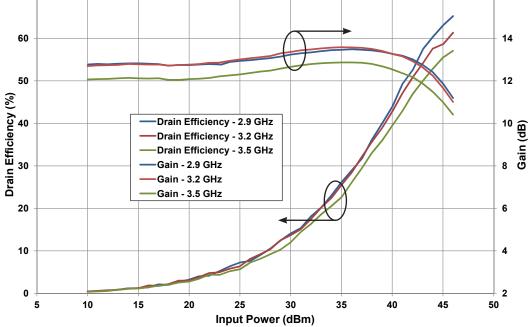
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#### **Typical Performance**





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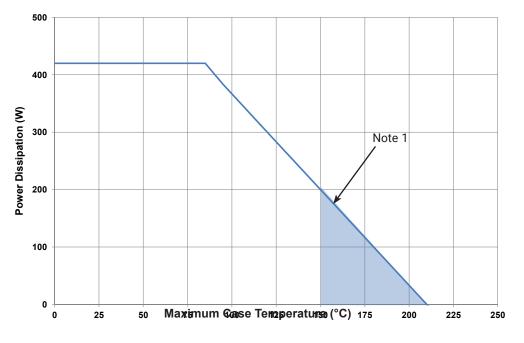


## CGHV35400F-AMP1 Application Circuit Bill of Materials

Designator	Description	Qty
R1	RES, 511, OHM, +/- 1%, 1/16W, 0603	1
R2	RES, 5.1, OHM, +/- 1%, 1/16W, 0603	1
C1	CAP, 6.8pF, +/-0.25%, 250V, 0603	1
C2, C7, C8	CAP, 10.0pF, +/-1%, 250V, 0805	3
C3	CAP, 10.0pF, +/-5%, 250V, 0603	1
C4, C9	CAP, 470pF, 5%, 100V, 0603, X	2
C5	CAP, 33000 pF, 0805, 100V, X7R	1
C6	CAP, 10uF 16V TANTALUM	1
C10	CAP, 1.0uF, 100V, 10%, X7R, 1210	1
C11	CAP, 33uF, 20%, G CASE	1
C12	CAP, 3300uF, +/-20%, 100V, ELECTROLYTIC	1
J1,J2	CONN, SMA, PANEL MOUNT JACK, FL	2
J3	HEADER, RT>PLZ, 0.1CEN LK 9POS	1
J4	CONNECTOR; SMB, Straight, JACK, SMD	1
W1	CABLE, 18 AWG, 4.2	1
-	PCB, RO4350, 2.5 X 4.0 X 0.030	1
Q1	CGHV35400F	1

#### CGHV35400F Power Dissipation De-rating Curve





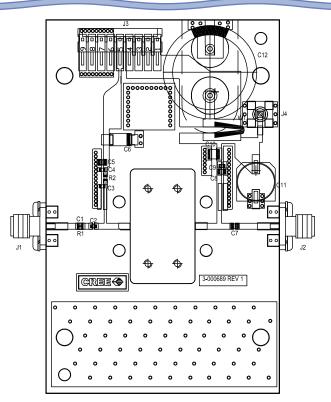
Note 1. Area exceeds Maximum Case Temperature (See Page 2).

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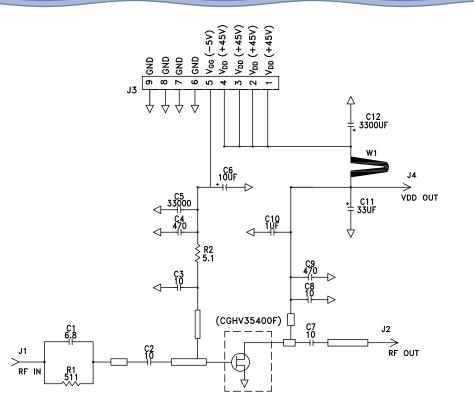
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#### CGHV35400F-AMP1 Application Circuit Outline



#### CGHV35400F-AMP1 Application Circuit Schematic



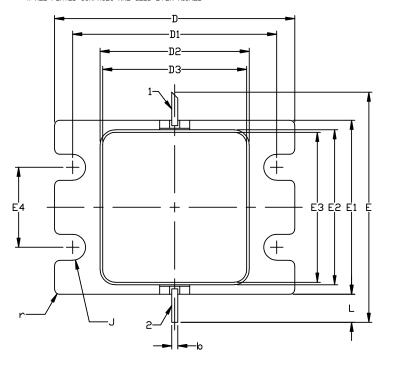
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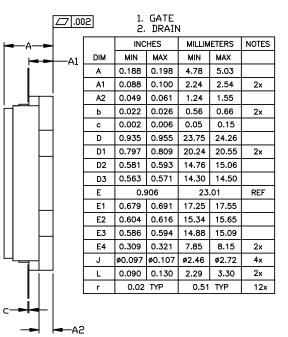
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#### Product Dimensions CGHV35400F (Package Type - 440210)

- NOTES: (UNLESS OTHERWISE SPECIFIED)
- 1. INTERPRET DRAWING IN ACCORDANCE WITH ANSI Y14.5M-2009
- 2. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF .020 BEYOND EDGE OF LID
- 3. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF .008 IN ANY DIRECTION
- 4. ALL PLATED SURFACES ARE GOLD DVER NICKEL



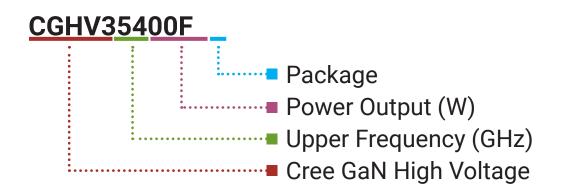


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Part Number System



Parameter	Value	Units
Upper Frequency <sup>1</sup>	3.5	GHz
Power Output	400	W
Package	Flange	-

Table 1.

**Note**<sup>1</sup>: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	6
н	7
J	8
К	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.

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## **Product Ordering Information**

Order Number	Description	Unit of Measure	Image
CGHV35400F	GaN HEMT	Each	CREWE CONTROLOGY
CGHV35400F-TB	Test board without GaN HEMT	Each	
CGHV35400F-AMP1	Test board with GaN HEMT installed	Each	

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